



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **SUNOHARA, Masahiro, et al.**

Group Art Unit: **2823**

Serial No.: **10/709,858**

Examiner: **Jarrett J. STARK**

Filed: **June 2, 2004**

P.T.O. Confirmation No.: **3857**

For: **A METHOD OF MANUFACTURING A PACKAGING STRUCTURE FOR
ELECTRONIC PARTS BURIED IN AN INSULATING FILM FORMED ON THE
ELECTRONIC PARTS AND A WIRING SUBSTRATE
(As Amended)**

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

February 23, 2006

Sir:

This Preliminary Amendment is being filed concurrently with a Request for Continued Examination in response to the Final Office Action dated **December 20, 2005**. Prior to further examination on the merits, please amend the above-identified application as follows:

U.S. Patent Application Serial No. 10/709,858
Response to Office Action dated December 20, 2005

IN THE TITLE:

Please amend the title to read as follows:

A METHOD OF MANUFACTURING A PACKAGING STRUCTURE FOR
ELECTRONIC PARTS BURIED IN AN INSULATING FILM FORMED ON THE
ELECTRONIC PARTS AND A WIRING SUBSTRATE